O-leading□ □□ □□ □□□□□

O-Leading□ PCB □□, PCB □□ □ PCB □□□□ (PCBA)□ □□□ EMS □□□□ □ □□ □□□ □□□□□□ □□ □□□□ □□□□. □□□ HDI PCB, □□ PCB, Rigid-Flexible PCB□ □□□ □□ □□ □ PCB □□□ □□□□□. . □□□ □□ □□ □□□ □□□□ □□ □ □□ □□□ □□□□□ □□□ □ □□□□.

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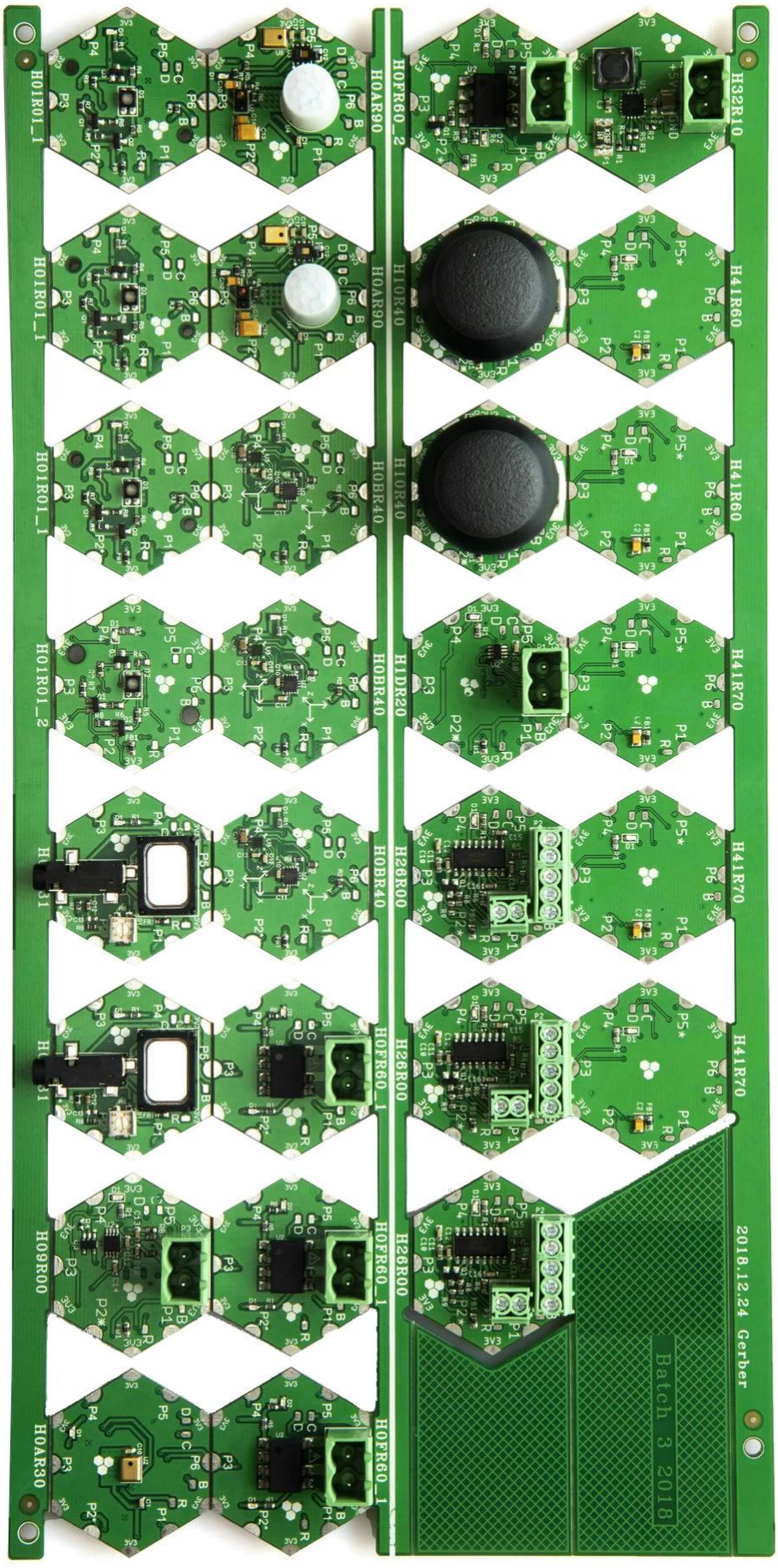
O-leading□ □□□ □□□□ □□ □□ □□ □□□ □□□ □□□ □□□□ PCB □ PCBA □ □□ □□□□ □□□□□ □□□□ □□ □□□□ □□□□ □□□□ □ □□ □□□ □□ □ □□□□.

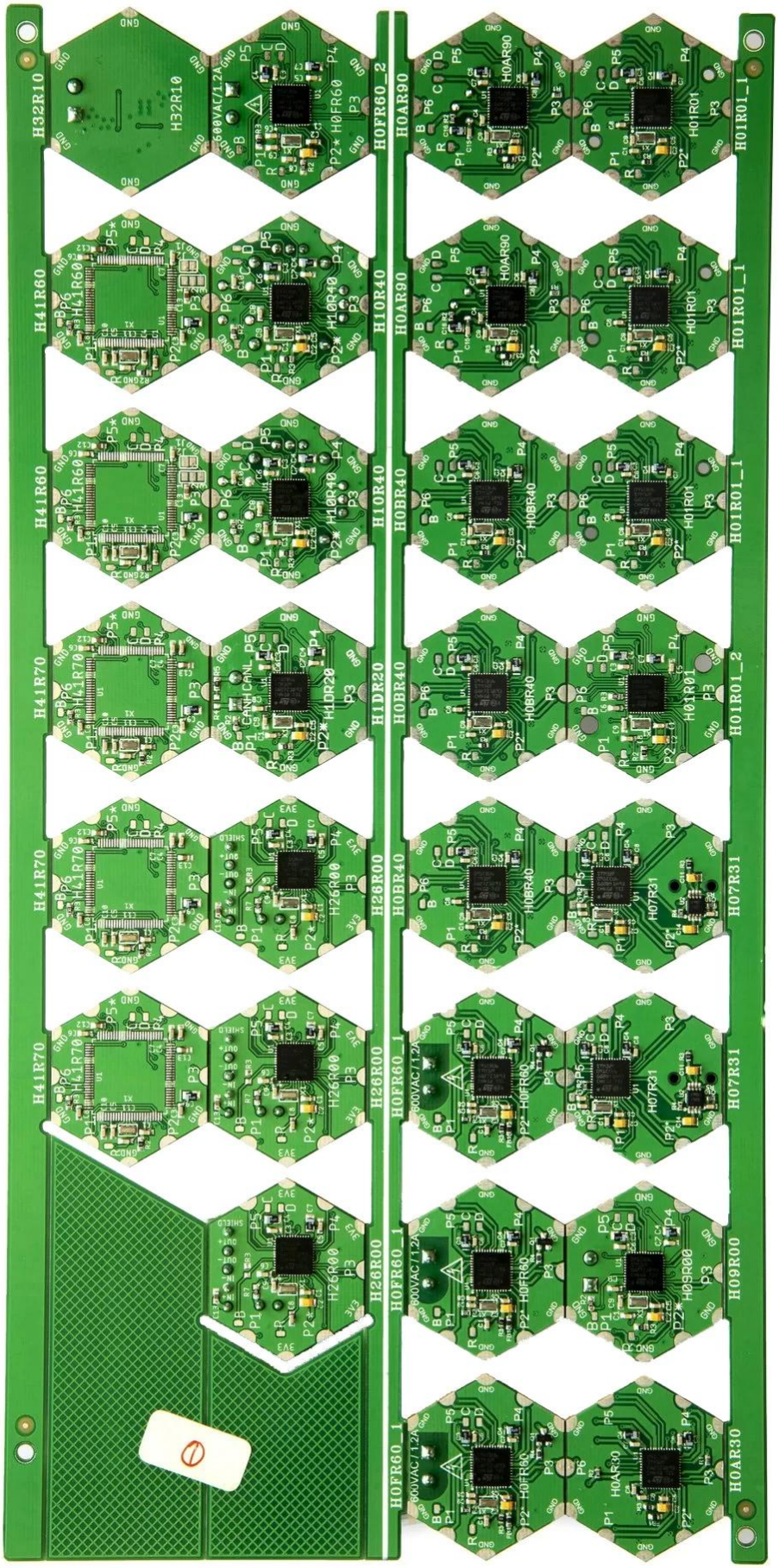
□□□ □□□ □□□ □□□ □□□□□□ :**□□□ Raspberry Pi 3B □ 3B 4B □□ □□ □□□□□ □□**

□□ □□

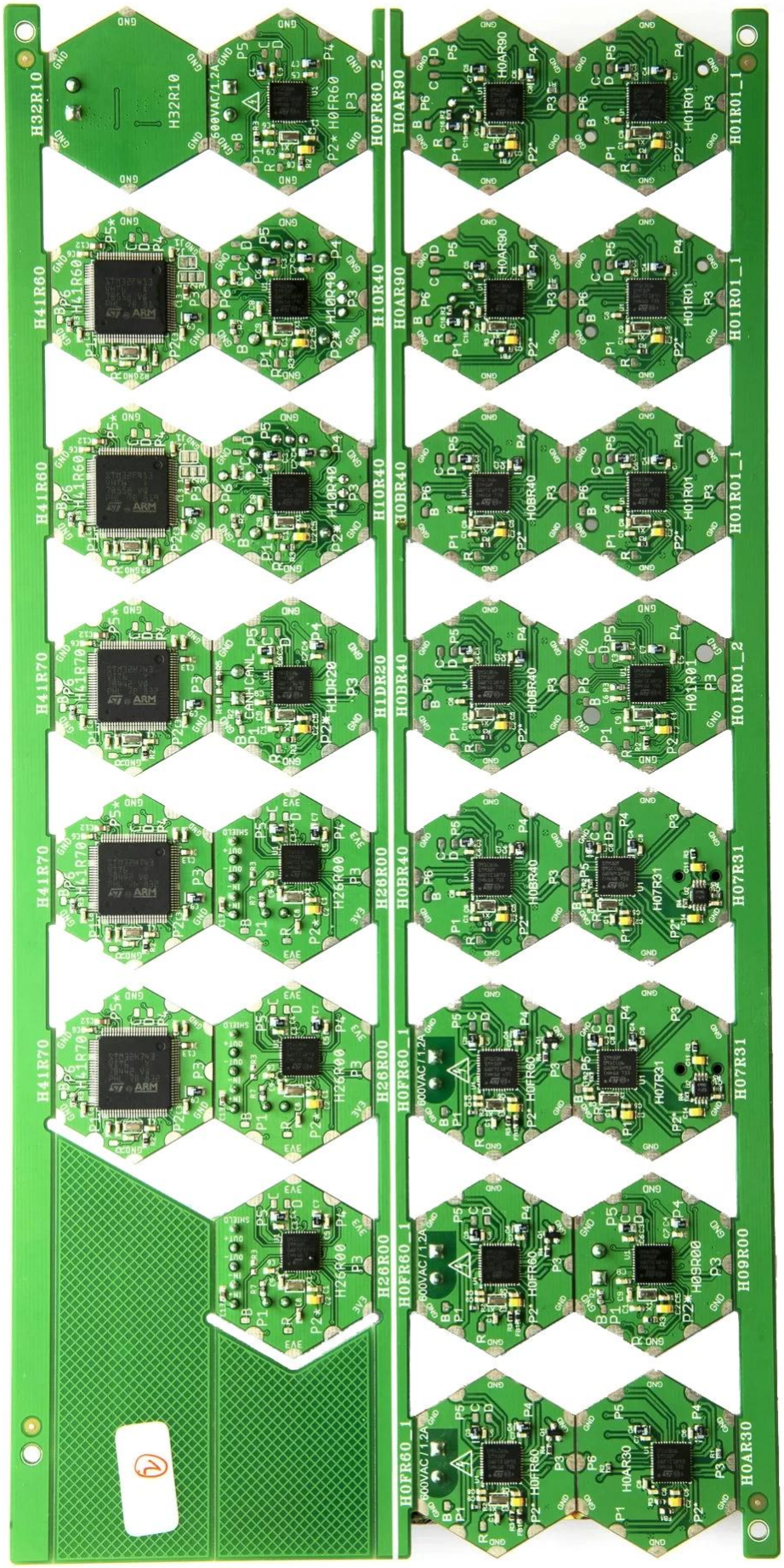
O-LEADING
To Be Reliable, To Be Valuable



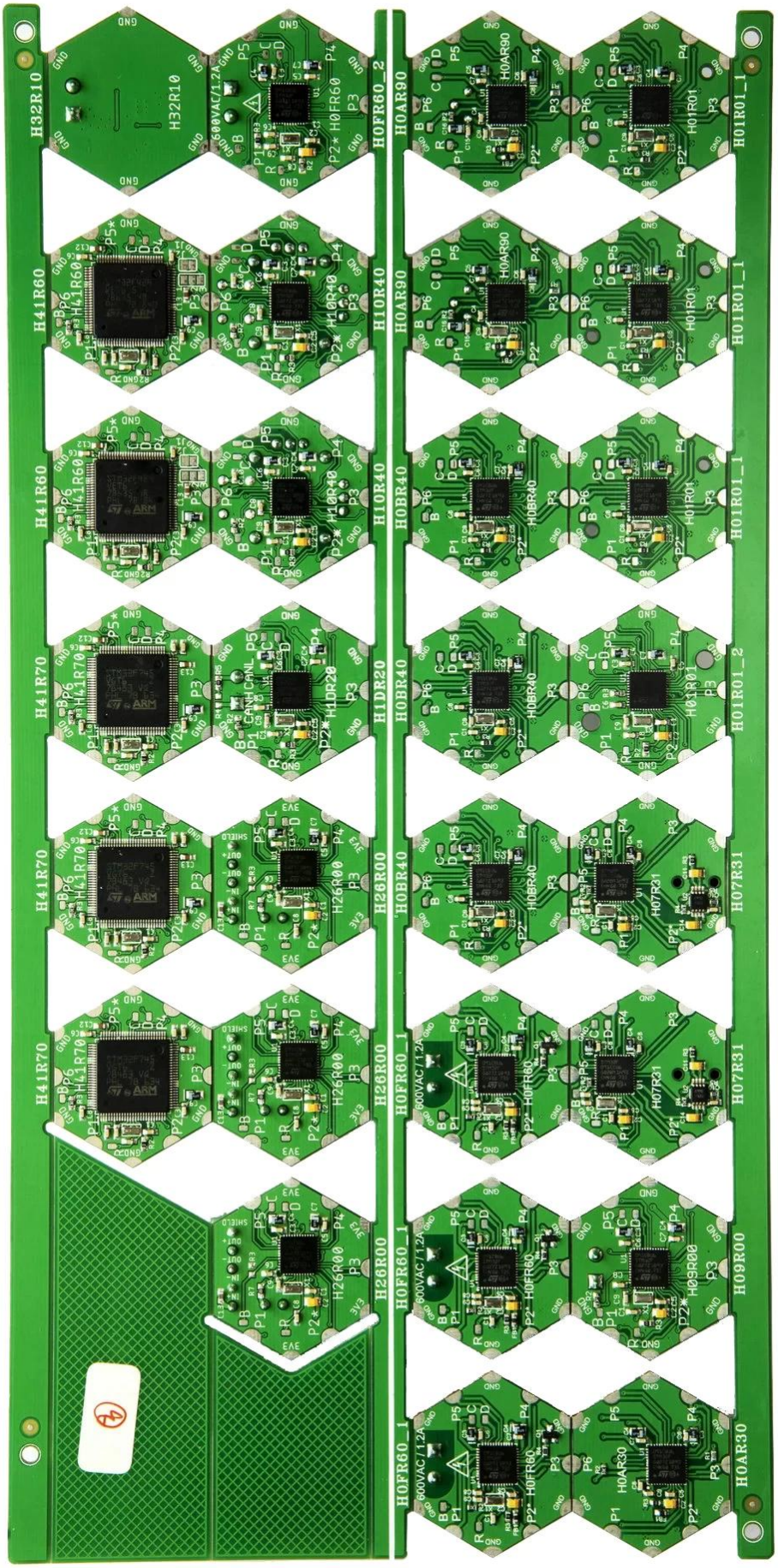
O-LEADING
To Be Reliable, To Be Valuable



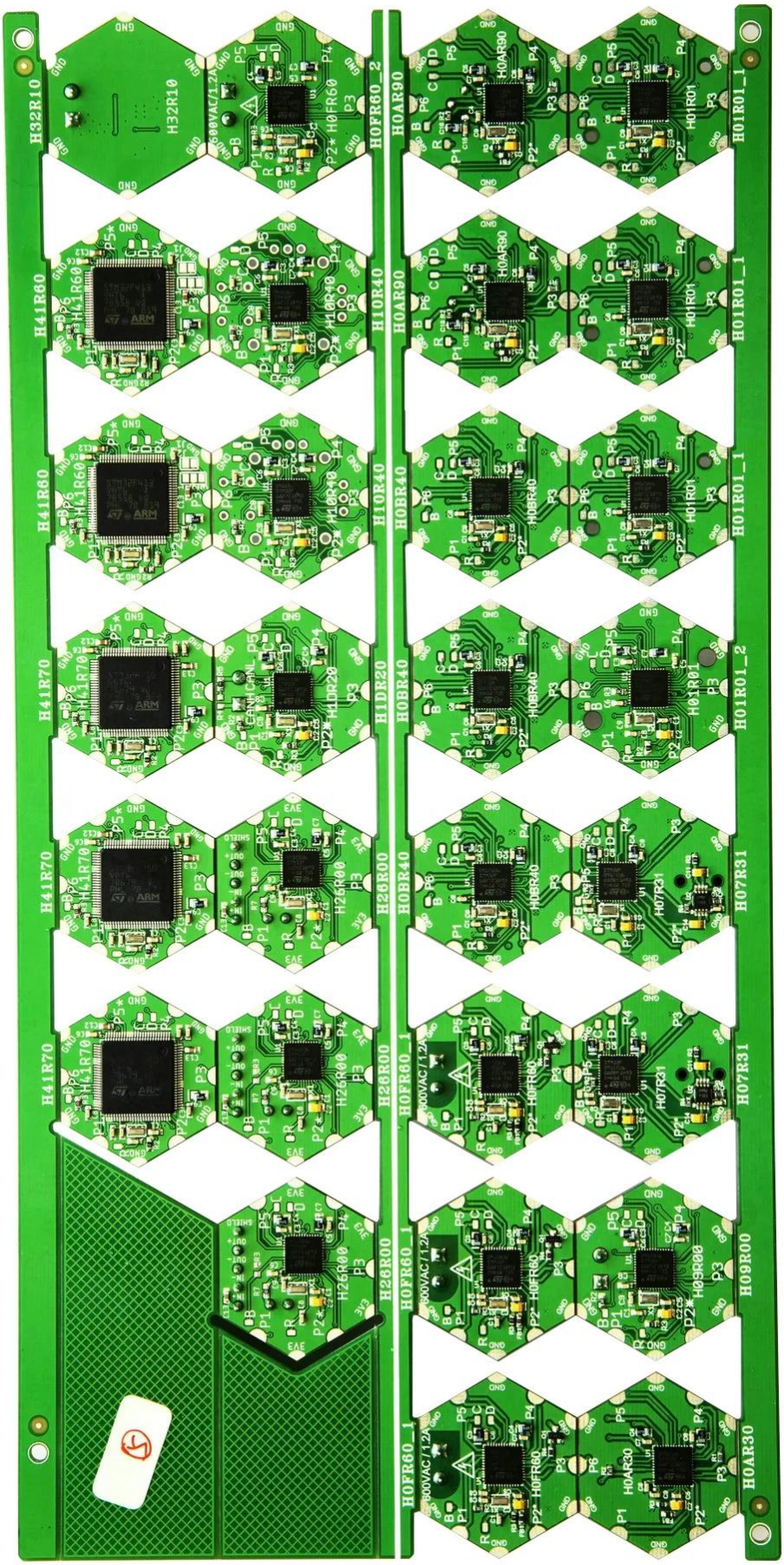
O-LEADING
To Be Reliable, To Be Valuable



O-LEADING
To Be Reliable, To Be Valuable

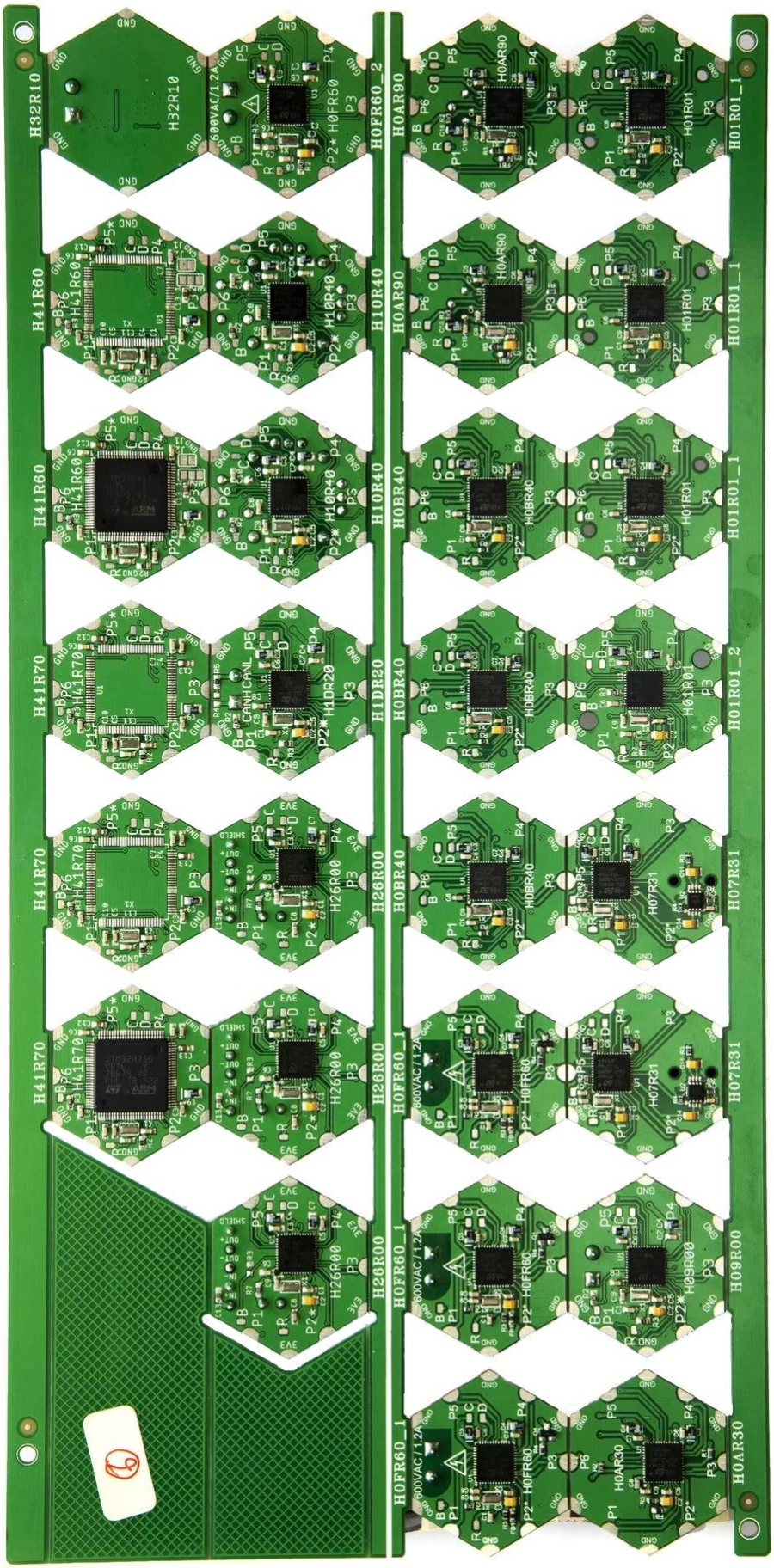


O-LEADING
To Be Reliable, To Be Valuable

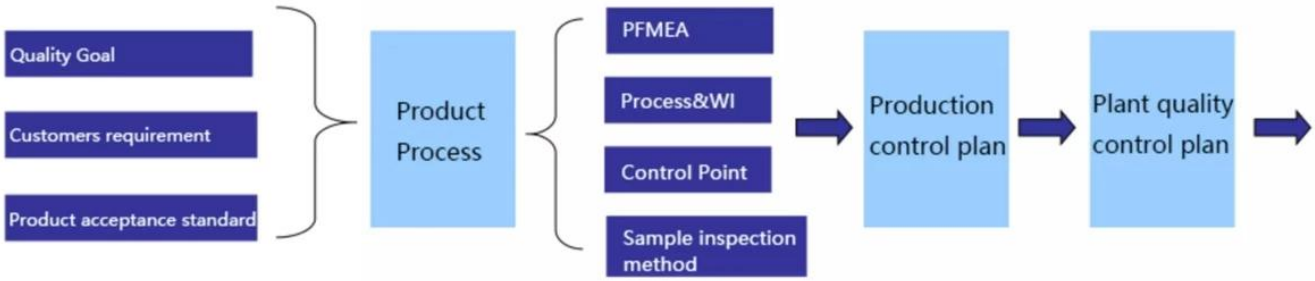


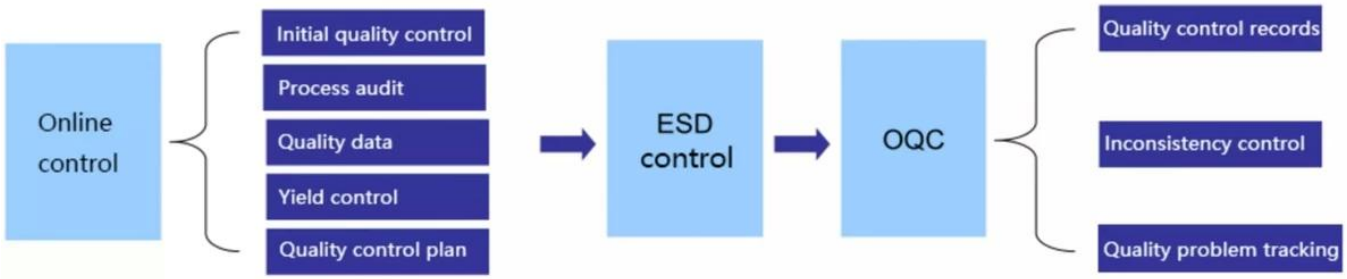
O-LEADING

To Be Reliable, To Be Valuable



Quality Control Process





Market Share

O-LEADING

Factory PCB

Automatic vacuum press machine

Drilling Machine

Pattern Plating Machine

Scrubbing Machine

Developing Machine

Routing Machine

High-speed flying probe machine

E-test Machine

Factory SMT

□□

CICC INSPECTION CERTIFICATION

CICC CERTIFICATION
嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE

Certificate No: 18118Q10347R0S

We hereby certify that

O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VOEUS ROAD CENTRAL HK

Business Add: 1313, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System**

Which fulfils the requirements of the following standards

GB/T19001-2016 idt ISO9001:2015

Scope of certification

Sales of printed circuit boards

Initial Issuance period: February 27, 2018

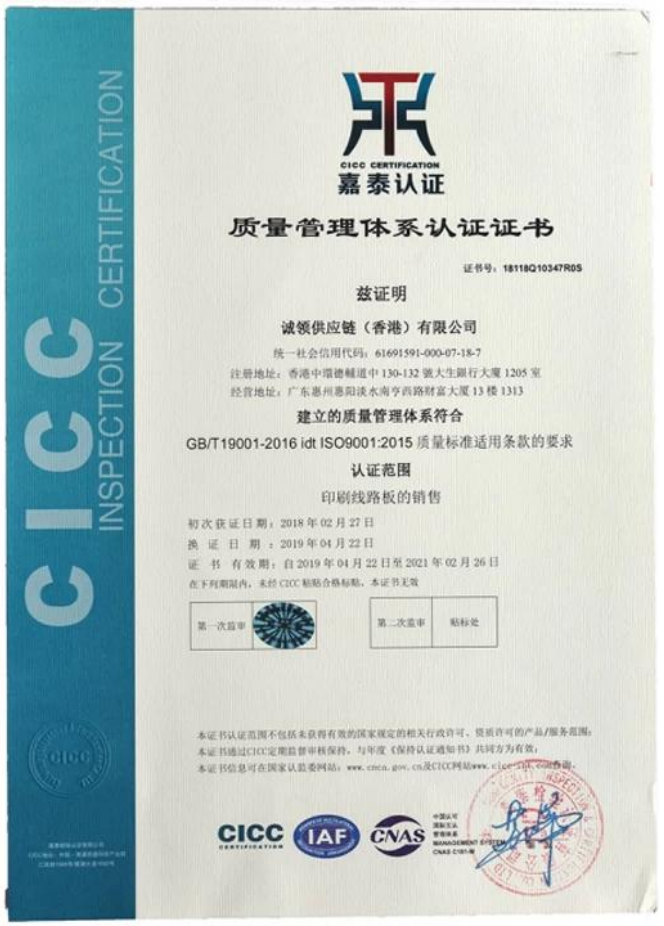
Renewal date: April 22, 2019

This certificate is valid during: April 22, 2019 ~ February 26, 2021

This certificate is invalid without CICC qualified label in the following period

First supervision and audit		Second supervision and audit	Qualified mark

CICC IAF CNAS



CICC INSPECTION CERTIFICATION

CICC CERTIFICATION
嘉泰认证

质量管理体系认证证书

证书号：18118Q10347R0S

兹证明

诚领供应链（香港）有限公司

统一社会信用代码：61691591-000-07-18-7

注册地址：香港中環德輔道中 130-132 號大生銀行大廈 1205 室

经营地址：广东惠州惠阳淡水南亨西路财富大厦 13 楼 1313

建立的质量管理体系符合

GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围

印刷线路板的销售

初次获证日期：2018 年 02 月 27 日

换 证 日 期 ：2019 年 04 月 22 日

证 书 有 效 期：自 2019 年 04 月 22 日至 2021 年 02 月 26 日

在下列期间内，未经 CICC 贴防伪标贴，本证书无效

第一次监审		第二次监审	贴标处

本证书认证范围不包括未获得有效的国家规定的相关行政许可、资质许可的产品/服务范围；

本证书通过CICC定期监督审核保持，与年度《保持认证通知书》共同方为有效；

本证书信息可在国家认监委网站：www.cnca.gov.cn及CICC网站www.cicc-ihk.com查询。

CICC IAF CNAS

O-LEADING SUPPLY CHAIN (HK) CO.,LIMITED

1313,FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. :	RP19-005089 - SZ
Date of Sample Received :	22 Mar 2019
Testing Period :	22 Mar 2019 - 30 Mar 2019
Test Requested :	Selected test(s) as requested by client.
Test Method :	Please refer to next page(s).
Test Results :	Please refer to next page(s).
Conclusion :	Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina Fan
Approved Signatory

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Attention: To check the authenticity of testing /inspection report & certificate, please contact us at telephone: (86-755) 8307 1443, or email: CN.Doccheck@sgs.com
SGS-CSTC Standards Technical Services Co., Ltd.
Shenzhen Branch
SGS Bldg, No.2, Jingshan Industrial Park, No.498, Jihua Road, Bantian, Longgang District, Shenzhen, China 518129 t (86-755) 25328888 f (86-755) 83106190 www.sgsgroup.com.cn
中国·深圳·龙岗区坂田吉华路430号江灏工业园4栋SGS大楼 邮编: 518129 t (86-755) 25328888 f (86-755) 83106190 e sgs.china@sgs.com
Member of the SGS Group (SGS SA)

Test Results :

Test Part Description :

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green"PCB"

Remarks :

(1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	001
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND

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Attention: To check the authenticity of testing /inspection report & certificate, please contact us at telephone: (86-755) 8307 1443, or email: CN.Doccheck@sgs.com
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中国·深圳·龙岗区坂田吉华路430号江灏工业园4栋SGS大楼 邮编: 518129 t (86-755) 25328888 f (86-755) 83106190 e sgs.china@sgs.com
Member of the SGS Group (SGS SA)

UL Product iQ™

ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD
ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

E490354

Type	Cond Width Min mm(in)	Min Edge mm(in)	Cond Thk mic(mil)	SS/ DS/ DSO	Max Area Diam mm(in)	Solder Limits C	sec	Max Oper Temp C	Flame Class	Meets UL796 DSR	CTI
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

并不是所有出现在本数据库中的公司名称和产品都满足了UL 跟踪检验服务的要求。只有带有 UL 标志的产品，才应该被视为经过UL认证，并满足UL 跟踪检验服务的要求。注意查看产品上的标志。

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□□ □□

PCB □□ □□	
□□□ □	1 □ -32 □
□□ □ □□ □□	1 / 3oz-12oz
□□ □ □□ / □□ □□	3.0mil / 3.0mil
□□ □ □□ / □□ □□	4.0mil / 4.0mil
Max Aspect Ratio	10 : 1
□□ □□	0.2mm ~ 5.0mm
□□ □□ □□ (□□)	635 * 1500mm
□□ □□ □□ □□	400 □
PIated □ □□	+/- 3mil
BIind / Buried Via (AII □□)	□
Via Fill (□□□, □□ □□)	□
□□ □□	FR-4, FR-4high Tg. □□□ □□ □□, □□□, □□□□□□□,Polyimide, □□□ □□
□□ □□	HASL, OSP, ENIG, HAL-LF, Immersion silver,Immersion □□, □ □□□, □□ □□

SMT □□ □□	
PCB □□	FR-4, CEM-1, CEM-3, □□□□ □□ □□
□□ PCB □□	510x460mm
□□ PCB □□	50x50mm
PCB □□	0.5mm-4.5mm
□□ □□	0.5-4mm
□□ □□ □□ □□	0201
□□ □ □□ □□ □□	0603 □□
□□ □□ □□ □□	15mm
□□ □□ □□	0.3mm
□□ BGA □ □□	0.4mm
□□ □□□	+/- 0.03mm

□□ □ □□

Shipping service

DHL WORLDWIDE EXPRESS TNT FedEx Express UPS

Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

□□□□ □□

1. O-Leading□ □□□ □□□ □□□□□?
□□□ □□□ □□□ □□□ □□ □□□□□.
1.1 □□□□□ ISO 9001 : 2008 □□□ □□ □□□□ □□□□□.
1.2 □□ □□□□ □□□ □□□□□□ □□□□ □□
1.3 □□□ □□□ □□ □ □□. □ : □□□ □□□, X- □□ □□, AOI (□□ □□ □□□) □ ICT (□□ □ □□□).
1.4 □□ □□ □□ □□□□□ □□ □□ □□ □□ □
1.5. □□□□ □□ □□ □ □□

2. O-Leading□ □□□ □□ □□□□ □□□□□?
□□ 10 □ □□ □□ □□□ (□ : □□, □□ □□)□ □□□ □ □, □ □ □□ □ □□□□□□□. □□ □□ RMB□ □□ □□ □□ 31 % □□□□□□. □□□ □□□□ □ □ □□□□□.
□□□ O-Leading□ □□□ □□□□□ □□□□□□. □□□ □□ □□, □□ □□ □ □□□ □□□ □□ □□□ □□□ □□□□ □□□□ □□□□. □□□ □□□ □□□ □□ □□□□ □□□□ □□ □□□□ □□□□.
□□□ □□□□ □□ □□□□□ □□□□.

3. O-Leading□ □□ □□□ □□□ □□ □ □ □□□?
□□□□ FR4, □ TG □ □□□ □□ □□, Rogers, Arlon, Telfon, □□□□ / □□ □□ □□, PI □

4. PCB 및 PCBA 제조 공정 파일은 무엇입니까?
4.1 부품 리스트의 BOM (Bill of Materials) : 부품 번호 포함, 제조업 명칭 및 수량 포함.
4.2 PCB Gerber 파일.
4.3 PCB 조립 도면 및 PCBA 참조 파일.
4.4 테스트 파일.
4.5 특수 공정 또는 테스트 요구 사항 설명 파일.

5. 일반 **PCB**의 제조에 대한 공정 흐름입니까?
재료 절단 → 내층 건조 → 내층 에칭 → 내층 AOI → 적층 준비 → 드릴링 구멍 → 구리 → PTH → 외층 건조 → 외층 패턴 도금 → 외층 에칭 → 외층 AOI → 솔더 마스크 → 문자 인쇄 → 표면 처리 → 외형 → E / T → 최종 검사.

6. HDI 보드에 대한 공정 흐름입니까?
내층 건조 필름 공정 : 세척 건조 준비, 필름 적층, VCP 노광, 현상 에칭, LDI 층.
세척 건조 필름 적층 기계, 노광 기계 모델 Mitsubishi 및 Hitachi, LDI 모델 Screen (중국), Automatic Exposing 모델 Hitachi의 제품을 선택 할 수 있습니다.

7. 표면 처리 공정 중 **O-** 종류 및 두께?
O-the 종류 ENIG, OSP, LF-HASL, 및 금 (도금 / 침지), 골드, 금,및 주석, 금 손가락 도금, 금 손가락 두께 및 골드 두께 선택 가능.
HDI의 일반적인 표면처리 OSP, ENIG, OSP + ENIG, BGA PAD 피치 0.3mm 이하 제품 일반적으로 사용하는 OSP OSP + ENIG의 표면처리 제품.

8. FPC의 최소 라인 간격 너비는 얼마입니까? **O-Leading**의 **SMT** 능력은 무엇 및 몇 입니까?
O-Leading의 최대는 8 레이어 FPC의 생산 및 가능. 최대 생산 크기 2000mm * 240mm입니다. 자세한 "Flex Capability"참조하십시오.
최소 라인 간격은 SMT 및 재료 유형에 따라 다릅니다.

9. PCB 제조 공정 중 주요 검사 항목은 무엇입니까?
외관;
치수 측정;
전기 테스트;
임피던스 제어;
PCB 청결;
솔더 강도;
환경 보호 요구.

10. PCB, PWB 및 **FPC**의 차이점 무엇입니까?
PCB는 일반 인쇄 회로 기판입니다.
PWB는 Printed Wire Board의 약자 또는 이전 인쇄 회로 기판 입니다.
FPC는 Flexible Printed Board의 약자입니다.

11. PCB 제조 공정 중 및 후 주의 사항은 무엇입니까?
PCB 제조 공정 및 후 주의 사항 다음과 같습니다.
재료 Tg 값 및 선택 고려하십시오.
재료 CTE 공정 및 선택 고려하십시오.
공정 및 후 처리 : 일반적인 PCB는 최소 50 및 최대 250 ℃의 공정 및 견뎌야합니다.
전기 테스트; 테스트 방법 선택은 PCB의 구조 / 재료 및 응용 분야 고려하십시오. 특수 PCB는 테스트 방법 및 장비 필요; 및 테스트 방법 및 장비 선택 및 및 고려하십시오.

12. O-leading rIgid-flex PCB의 장점 무엇입니까?
O-leading의 rigid-flex PCB는 FPC와 PCB의 장점 및 결합하여 및 제품 크기 감소 및 제품 신뢰성 및 제품 조립 공정 단계 감소 및 제품 조립 공정 및 제품 비용 및 감소.

13. 제품의 장점 무엇입니까?

□□□□ □□ □□□□ POLAR INSTRUMENTS□ □□ □□□ □□, SI6000 □□□ □ CITS 500s □□□ □□□□ □□□□□.
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